

# 3000W Surface Mount Transient Voltage Suppressor

#### **FEATURES**

- AEC-Q101 qualified
- Moisture sensitivity level: level 1, per J-STD-020
- Meets IEC 61000-4-2 (Level: 4) / ISO 10605 (Level: L4)
- Meets ISO 7637-2 (Pulse 1/2a/2b/3a/3b)
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Motor for BLDC
- Lighting application
- Battery Management System
- Automotive

#### **MECHANICAL DATA**

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Weight: 0.21g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
$V_{WM}$	18	V		
$V_{BR}$	21.1	V		
$P_{PPM}$	3000	W		
T <sub>J MAX</sub>	175	°C		
Polarity	Uni-directional			
Package	DO-214AB (SMC)			





DO-214AB (SMC)

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	SYMBOL	VALUE	UNIT		
Non-repetitive peak impulse power dissipation with 10/1000µs waveform (1)	P <sub>PPM</sub>	3000	W		
Steady state power dissipation at T <sub>L</sub> =25°C <sup>(2)</sup>	$P_D$	8.5	W		
Peak forward surge current 8.3 ms single half sine-wave	I <sub>FSM</sub>	300	Α		
Junction temperature	T <sub>J</sub>	-55 to +175	°C		
Storage temperature	T <sub>STG</sub>	-55 to +175	°C		

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#### Notes:

- 1. Non-repetitive current pulse per fig. 3 and derated above T<sub>A</sub>=25°C per fig. 1
- 2. Units mounted on PCB (16mm x 16mm Cu pad test board)





THERMAL PERFORMANCE						
PARAMETER	SYMBOL	TYP	UNIT			
Junction-to-lead thermal resistance per diode	R <sub>OJL</sub>	17	°C/W			
Junction-to-ambient thermal resistance per diode	$R_{\Theta JA}$	50	°C/W			
Junction-to-case thermal resistance per diode	R <sub>eJC</sub>	10	°C/W			

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)											
Part Marking		I <sub>R</sub> max at V <sub>wм</sub>		V <sub>BR</sub> at I <sub>T</sub> <sup>(1)</sup>			V <sub>C</sub> at I <sub>PPM</sub> 10/1000 μs		R <sub>D</sub> 10/1000 μs	$\alpha T^{(2)}$	
number	code			min	typ	max	I <sub>T</sub>	max			max
		μΑ	V		V		mA	V <sup>(3)</sup>	Α	Ω	10 <sup>-4</sup> /°C
3KSMC21AH	3K21A	3	18	20	21.1	22.2	1	29.2	102.7	0.079	9.2

#### Note:

1. Pulse test: tp < 30 ms

2. To calculate  $V_{\text{BR}}$  or  $V_{\text{C}}$  versus junction temperature, use following formulas:

 $V_{BR}$  at  $T_J = V_{BR}$  at 25°C x (1 +  $\alpha T$  x ( $T_{J}$ -25))

 $V_{C}$  at  $T_{J} = V_{C}$  at 25°C x (1 +  $\alpha T$  x ( $T_{J}$ -25))

3. To calculate maximum clamping voltage at other surge level, use the following formula:

 $V_{Cmax} = V_C - R_D x (I_{PP} - I_{PPappli})$  where  $I_{PPappli}$  is the surge current in the application.

ORDERING INFORMATION				
ORDERING CODE	PACKAGE	PACKING		
3KSMC21AH V7G	SMC	850 / 7" reel		
3KSMC21AH V6G	SMC	3,000 / 13" reel		



### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Pulse Power or Current vs. Initial Junction Temperature

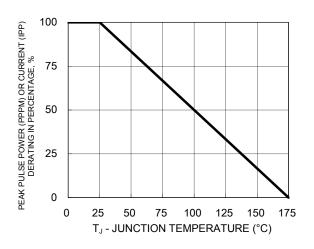


Fig.3 Clamping Power Pulse Waveform

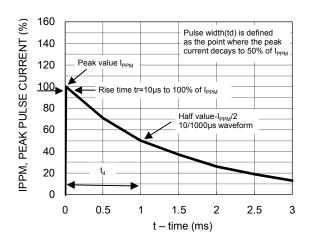


Fig.5 Typical Transient Thermal Impedance

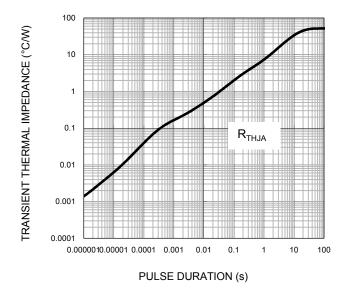


Fig.2 Steady State Power Derating

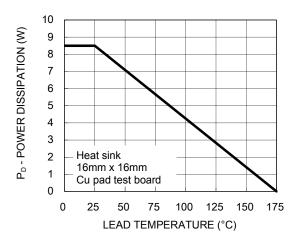


Fig.4 Typical Junction Capacitance

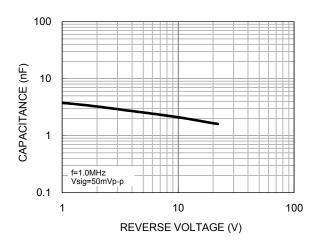
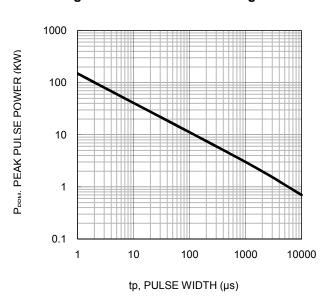


Fig.6 Peak Pulse Power Rating Cure

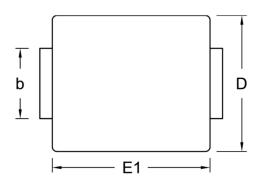


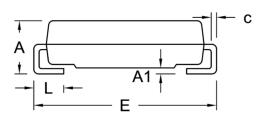




## **PACKAGE OUTLINE DIMENSIONS**

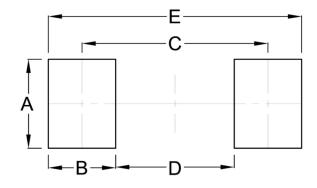
DO-214AB (SMC)





DIM.	Unit	(mm)	Unit (inch)		
Dilvi.	Min.	Min. Max.		Max.	
Α	2.00	2.62	0.079	0.103	
A1	-	0.20	-	0.008	
b	2.90	3.20	0.114	0.126	
С	0.15	0.31	0.006	0.012	
D	5.59	6.22	0.220	0.245	
Е	7.75	8.13	0.305	0.320	
E1	6.60	7.11	0.260	0.280	
L	1.00	1.60	0.039	0.063	

## **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	3.30	0.130
В	2.50	0.098
С	6.90	0.272
D	4.40	0.173
E	9.40	0.370

## **MARKING DIAGRAM**



Note: Cathode band for unidirectional products only

P/N = Marking Code YW = Date Code

F = Factory Code



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